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RoHS Reach Halogen Free Pb Free

交货型号	C2012CH1H332JT****	<u> </u>
用途	一般等级	
特点	General 一般(~75V)	
系列	C2012 [EIA 0805]	
状态	▲ 量产体制(新设计非推荐)	

尺寸		
长度(L)	2.00mm ±0.20mm	
宽度(W)	1.25mm ±0.20mm	
厚度(T)	0.60mm ±0.15mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.50mm Min.	
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)	
1世存/产益/即/ŋ (ГА)	0.90mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)	
1世存/产益4µ/ŋ (ГD)	0.70mm to 0.90mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)	
1世仔/产益14/19 (10)	0.90mm to 1.20mm(Reflow Soldering)	

	电气特性	
电容	$3.3nF \pm 5\%$	
 额定电压	50VDC	
	$CH(0\pm 60 ppm/^{\circ} C)$	
Q (Min.)	1000	
	10000M Ω	

	其他
焊接方法	流体
库按方法	回流
AEC-Q200	NO
包装形式	纸编带(180mm卷筒)
包装个数	4000pcs

 $!\ \mbox{Images}$  are for reference only and show exemplary products.

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特性图表(这是参考数据,并不保证产品的特性。)

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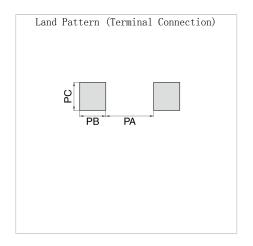
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## Associated Images



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